# PROCEEDINGS OF SPIE

# MOEMS and Miniaturized Systems XXII

Hans Zappe Wibool Piyawattanametha Yong-Hwa Park Editors

30–31 January 2023 San Francisco, California, United States

Sponsored by SPIE

Co-sponsored by Mirrorcle Technologies, Incorporated (United States)

Published by SPIE

Volume 12434

Proceedings of SPIE 0277-786X, V. 12434

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MOEMS and Miniaturized Systems XXII, edited by Hans Zappe, Wibool Piyawattanametha, Yong-Hwa Park, Proc. of SPIE Vol. 12434, 1243401 · © 2023 SPIE 0277-786X · doi: 10.1117/12.2675520 The papers in this volume were part of the technical conference cited on the cover and title page. Papers were selected and subject to review by the editors and conference program committee. Some conference presentations may not be available for publication. Additional papers and presentation recordings may be available online in the SPIE Digital Library at SPIEDigitalLibrary.org.

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Please use the following format to cite material from these proceedings: Author(s), "Title of Paper," in *MOEMS and Miniaturized Systems XXII*, edited by Hans Zappe, Wibool Piyawattanametha, Yong-Hwa Park, Proc. of SPIE 12434, Seven-digit Article CID Number (DD/MM/YYYY); (DOI URL).

ISSN: 0277-786X ISSN: 1996-756X (electronic)

ISBN: 9781510659735 ISBN: 9781510659742 (electronic)

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